506030013 04/24/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUNYEUB SUH	04/14/2020
SANG JOON KIM	04/14/2020
HANKYU LEE	04/14/2020

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number		
Application Number:	16857416		

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NAME OF SUBMITTER:	JONATHAN D. SCHLAIFER	
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DATE SIGNED:	04/24/2020	

Total Attachments: 2

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PATENT 506030013 REEL: 052485 FRAME: 0714

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

	Xo	POX 2002-02 X 5. X 5	370.50	
As a below-named inventor, I hereby	declare the	at this decla	ration is di	rected to the application attached hereto
or to United States Application Numb	er or PCT I	Internationa	l Application	on Number
filed	on			(if applicable), entitled:
	3 WAKE-U TEM INCL			PERATING METHOD OF IMPLANT DEVICE
The above-identified application was	made or au	uthorized to	be made l	oy me.
I believe I am the original inventor or application.	an original	joint invent	or of a clai	med invention in the above-identified
I hereby acknowledge that any willful 1001 by fine or imprisonment of not i				laration is punishable under 18 USC
I have reviewed and understand the	contents of	the above-	identified a	pplication, including the claims.
me to be material to patentability as	defined in 3 alable betw	7 CFR 1.56 een the filir	including g	demark Office all information known to for continuation-in-part applications, he prior application and the national or
	£	\SSIGNMI	ENT	
For valuable consideration, I, as a be	low-named	l assignor, l	nereby ass	ign to:
Samsung Electronics Co., Lt 129, Samsung-ro, Yeongton Suwon-si, Gyeonggi-do 166' Republic of Korea	g-gu			
and its successors and assigns (colle	actively her	einafter call	ed "the As	signee"), the entire right, title, and
interest throughout the world in the it	nventions ar	nd improvei	ments that	are the subject of the application
identified in the above declaration, w 16/857,416	hich is Unite	ed States A April 2	pplication 4, 2020	Number or PCT International Application
I authorize and request the attorneys	appointed pplication n	in the abov umber and	e-identified the filing d	ate of the above-identified application
identified application under the Intere	ns granted f ation, and t national Cor atent Conve in my nam	for any of the he right to one of the heart on for ention, and e or in its o	e invention plaim priori the Protect all other to wn name f	ns and improvements that are the ty based on the filing date of the above- position of Industrial Property, the Patent eaties of like purposes; and I authorize tor patents, utility models, design

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that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may

reasonably request to effectuate fully this Assignment.

PATENT REEL: 052485 FRAME: 0715

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	Junyeub SUH				
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